

200V PNP LOW $V_{\text{CE}(\text{sat})}$ TRANSISTOR IN SOT-89

Features

- BV_{CEO} > -200V
- BV_{ECO} > -2V
- Continuous current I_{C(cont)} = 2A
- V_{CE(sat} < -160mV @ -1A
- R_{CE(sat)}=130mΩ
- P_D = 2.4W
- 2 Amps continuous current
- Up to 5 Amps peak current
- Very low saturation voltage
- Enhanced switching performance

Applications

DC-DC Convertors

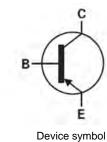
Mechanical Data

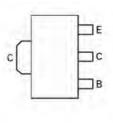
- Case: SOT-89
- UL Flammability Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Matte Tin Finish
- Weight: 0.052 grams (approximate)

SOT-89



Top View



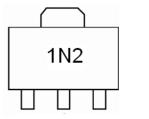


Pin Configuration

Ordering Information

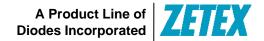
Product	Marking	Reel size (inches)	Tape width (mm)	Quantity per reel
ZXTP03200BZTA	1N2	7	12	1000

Marking Information



1N2 = Product type Marking Code





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Maximum Ratings @T_A = 25°C unless otherwise specified

Characteristic	Symbol	Value	Unit
Collector-Base Voltage	V _{CBO}	-220	V
Collector-Emitter Voltage	V _{CEO}	-200	V
Emitter-Base Voltage	V _{EBO}	-7	V
Continuous Collector Current (Note a)	Ic	-2	A
Base Current	IB	-1	A
Peak Pulse Current	I _{CM}	-5	A

Thermal Characteristics

Characteristic	Symbol	Value	Unit
Power Dissipation at $T_A = 25^{\circ}C$ (Note a) Linear derating factor	PD	1.1 8.8	W mW /°C
Power Dissipation at $T_A = 25^{\circ}C$ (Note b) Linear derating factor	PD	1.8 14.4	W mW /°C
Power Dissipation at $T_A = 25^{\circ}C$ (Note c) Linear derating factor	PD	2.4 19.2	W mW /°C
Power Dissipation at $T_A = 25^{\circ}C$ (Note d) Linear derating factor	PD	4.46 35.7	W mW /°C
Power Dissipation at $T_A = 25^{\circ}C$ (Note e) Linear derating factor	PD	38.7 309.6	W mW /°C
Junction to Ambient (Note a)	R _{θJA}	117	°C/W
Junction to Ambient (Note b)	R _{θJA}	68	°C/W
Junction to Ambient (Note c)	R _θ JA	51	°C/W
Junction to Ambient (Note d)	R _{θJA}	28	°C/W
Junction to Lead (Note e)	R _{θJL}	3.23	°C/W
Operating and Storage Temperature Range	T _J , T _{STG}	-55 to +150	°C

a. For a device surface mounted on 15mm X 15mm X 1.6mm FR4 PCB with high coverage of single sided 1 oz copper, in still air conditions
b. Mounted on 25mm X 25mm X 1.6mm FR4 PCB with high coverage of single sided 1 oz copper, in still air conditions.
c. Mounted on 25mm X 25mm X 1.6mm FR4 PCB with high coverage of single sided 2 oz copper, in still air conditions. Notes:

d. As (c) above measured at t<5 seconds

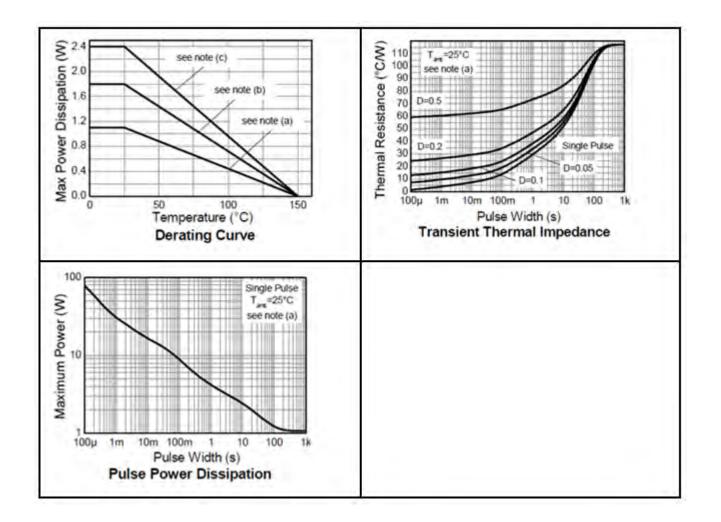
e. Junction to lead from collector Tab. Typical





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Thermal Characteristics and Derating information





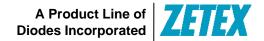
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Electrical Characteristics @T_A = 25°C unless otherwise specified

	<u> </u>		-			T (0)
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
Collector-Base Breakdown Voltage	V _{(BR)CBO}	-220	-245		V	I _C = -100μA
Collector-Emitter Breakdown Voltage	V _{(BR)CER}	-220	-245		V	$I_{C} = -1\mu A, R_{BE} \le 1k\Omega$
Collector-Emitter Breakdown Voltage (Note f)	V _{(BR)CEO}	-220	-225		V	I _C = -10mA
Emitter-Base Breakdown Voltage	V _{(BR)EBO}	-7	-8.4		V	$I_E = -100\mu A$
Collector-Base Cutoff Current	I _{CBO}		<1	-50 -0.5	nA μA	$V_{CB} = -200V$ $V_{CB} = -200V$, $T_{amb} = 100^{\circ}C$
Emitter Cutoff Current	I _{EBO}		<1	-10	. nA	$V_{EB} = -6V$
Static Forward Current Transfer Ratio (Note f)	h _{FE}	100 100 20	195 179 50 5	300		$\begin{split} & I_{C} = -10 \text{mA}, \ V_{CE} = -5 \text{V} \\ & I_{C} = -1 \text{A}, \ V_{CE} = -5 \text{V} \\ & I_{C} = -2 \text{A}, \ V_{CE} = -5 \text{V} \\ & I_{C} = -5 \text{A}, \ V_{CE} = -5 \text{V} \end{split}$
Collector-Emitter Saturation Voltage (Note f)	V _{CE(SAT)}		-37 -120 -130 -160	-50 -155 -160 -260	mV mV mV mV	$I_{C} = -100$ mA, $I_{B} = -10$ mA $I_{C} = -500$ mA, $I_{B} = -25$ mA $I_{C} = -1A$, $I_{B} = -100$ mA $I_{C} = -2A$, $I_{B} = -400$ mA
Base-Emitter Saturation Voltage (Note f)	V _{BE(sat)}		-940	-1100	mV	$I_{\rm C} = -2A, I_{\rm B} = -400 {\rm mV}$
Base-Emitter Turn-On Voltage (Note f)	V _{BE(ON)}		-840	-1000	mV	I _C = -2A, V _{CE} = -5V
Output Capacitance (Note f)	Cobo		31		pF	V _{CB} = -10V. f = 1MHz
Transition Frequency	f _T		105		MHz	$V_{CE} = -10V, I_{C} = -100mA$ f = 50MHz
Delay Time	t _d		21		ns	
Rise Time	tr		18		ns	$V_{CC} = -50V, I_{C} = -1A$
Storage Time	Ts		680		ns	$I_{B1} = -I_{B2} = -100 \text{mA}$
Fall Time	T _f		75		ns	

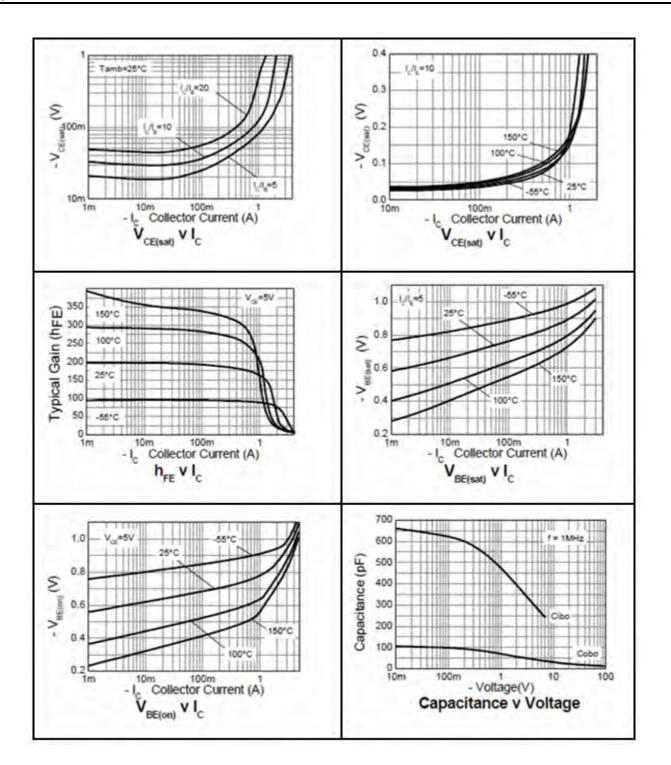
Notes: f. Measured under pulsed conditions. Pulse width = 300 μ s. Duty cycle $\leq 2\%$



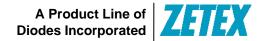


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Typical Characteristics

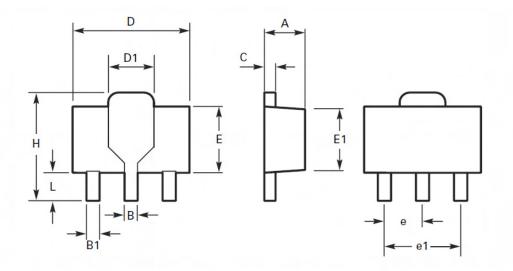






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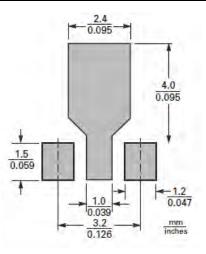
Package Outline Dimensions



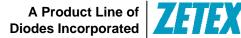
DIM	Millimeters		Inches		DIM	Millimeters		Inches	
	Min	Max	Min	Max		Min	Мах	Min	Max
А	1.40	1.60	0.550	0.630	E	2.29	2.60	0.090	0.102
В	0.44	0.56	0.017	0.022	E1	2.13	2.29	0.084	0.090
B1	0.36	0.48	0.014	0.019	е	1.50 BSC		0.059 BSC	
С	0.35	0.44	0.014	0.017	e1	3.00 BSC		0.118 BSC	
D	4.40	4.60	0.173	0.181	Н	3.94	4.25	0.155	0.167
D1	1.52	1.83	0.064	0.072	L	0.89	1.20	0.035	0.047

Note: Controlling dimensions are in millimeters. Approximate dimensions are provided in inches

Suggested Pad Layout







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